



PATENT

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chopra et al.

Serial No.: 10/620,002

Filed: July 14, 2003

For: SLURRY FOR USE WITH FIXED-
ABRASIVE POLISHING PADS IN
POLISHING SEMICONDUCTOR DEVICE
CONDUCTIVE STRUCTURES THAT
INCLUDE COPPER AND TUNGSTEN

Confirmation No.: 7481

Examiner: L. Umez-Eronini

Group Art Unit: 1765

Attorney Docket No.: 2269-4373.2US
(00-0036.02/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

October 23, 2006

Date

Signature

Erika Gandre
Name (Type/Print)

Do-Not-Enter
Amendment

L. UMEZ,
11/16/2006

Entered per RCE
filed 12/4/06
la

RESPONSE TO FINAL OFFICE ACTION

Mail Stop Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

This Response follows the final Office Action of August 21, 2006, the shortened statutory period for response to which expires on November 21, 2006. This Response is being submitted within two months of the mailing date of the Final Office Action.